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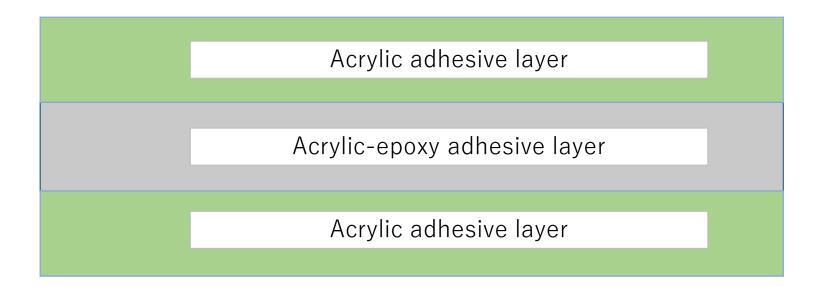
# Molecule Gradient Double Tack Tape

## Heat resistance tape [200Y]

2017. Nov.

### Structure of 200Y-series adhesive

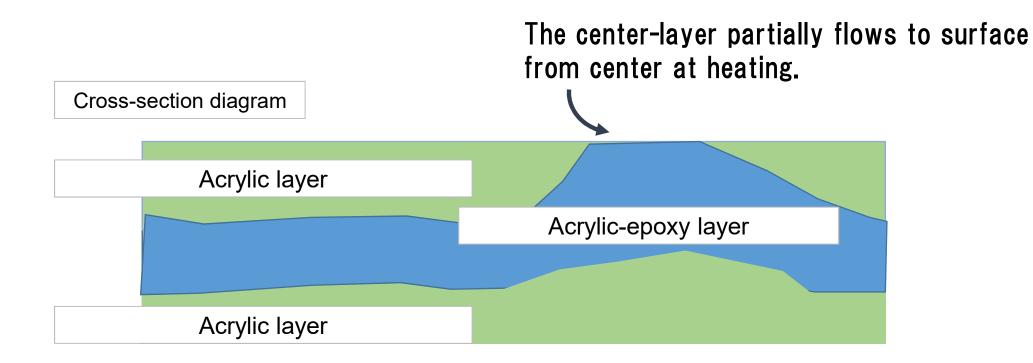
The structure of 200Y-series is as follow.



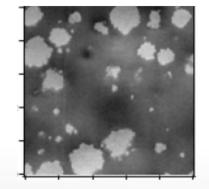
The 200Y-series tape has three-layers structure. The 200Y-series tape has epoxy-layer that has very strong adhesive force in centerlayer.



### Inside-flowing at heating



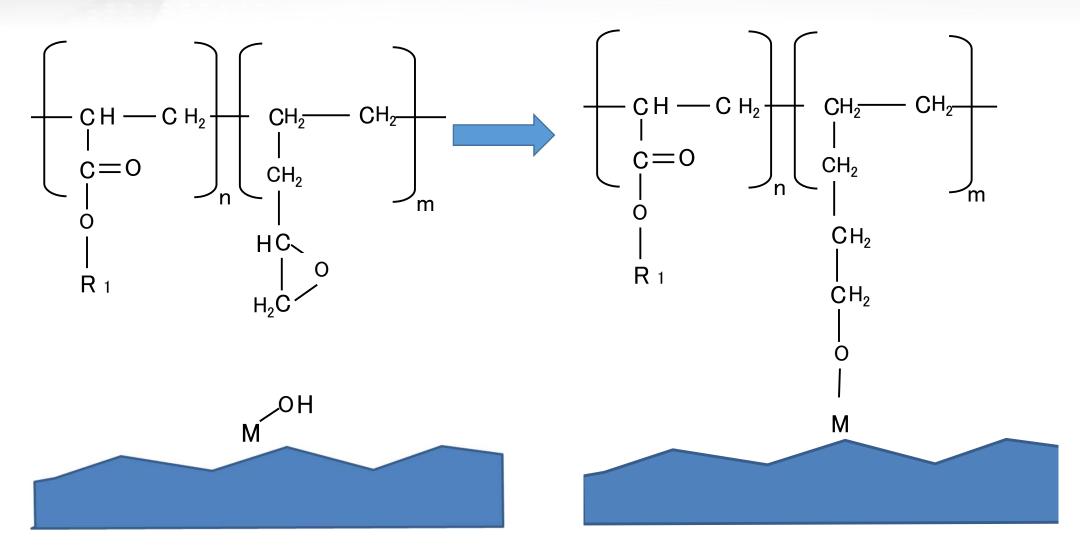
Surface diagram





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### Adhesive mechanism



The central acrylic-epoxy layer has chemical-bonding to surface that has hydroxyl-group or active-radical carbonyl group.



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### **Products & Characteristic**

Product	Thickness (t=mm)	Color	Peel adhesive SUS 23°C	Peel adhesive SUS 200°C × 1h					
200Y12.5	0.0125	Transparent	6.5	7					
200Y30	0.03	Transparent	8.5	12.5					
200Y50	0.05	Transparent	14.5	18					



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### **Basic characteristics**

Adhesion											
	SL	JS	Alumi	inium	Gla	ISS	Glass epoxy				
	Before cure	After cure									
200Y12,5	6.9	7.1	5.4	6.3	7.1	8.5	4.3	5.2			
200Y30	8.6	12.3	7.5	11.4	7.5	10.4	7.1	9.3			
200Y50	14.5	17.9	16.7	16.8	13.2	18.1	12.4	14.2			

#### Elongation

	Elongat	ion %	breaking strength N								
	Before cure	After cure	Before cure	After cure							
200Y12.5	264	1.3	253	1.2							
200Y30	350	2.6	304	3.1							
200Y50	438	3.8	387	4.5							

#### Evaluated

KGK: 200Y12.5 200Y30 200Y50

#### Test method

Test Pa	rameters						
Materials	SUS plate Aluminium Glass Glass epoxy						
Assembly Procedure-Rolled	Rolled Force Speed	2-times 20N 300mm/s					
	Temperter (Before cure)	23°C					
Test Conditions	Temperter (After cure)	200°C					
	Dwell Time	1h					



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### **Adhesion strengthening of 200Y**

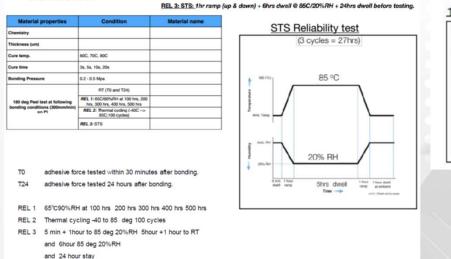
### **<u>180 deg peel</u> Product : 200Y50 0.05t**

											 															_
Temperature	°C	;	60	60	60	60	60	60	60	60	70	70	70	70	70	70	70	70	80	80	80	80	80	80	80	80
Cure	seco	ond	3	3	5	5	10	10	20	20	3	3	5	5	10	10	20	20	3	3	5	5	10	10	20	20
Bonding Pressure	Мр	a	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5	0.2	0.5
RT	Adherend	unit																								
то	<b>PI/SUS</b>	N/cm	0.4	0.5	1.2	1.5	3.8	3.9	4.2	4.4	1.1	1.2	2.5	2.8	3.7	4.1	4.9	<mark>5.1</mark>	2.5	2.7	3.5	3.6	5.8	<mark>6.1</mark>	6.5	6.7
T24	PI/SUS	N/cm	0.5	0.6	1.5	1.8	3.9	4.1	4.4	4.6	1.3	1.4	2.7	2.9	3.8	4,2	5.1	5.4	2.8	2.9	3.6	3.8	6.1	6.2	6.7	6.9

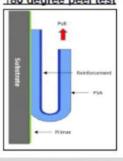
T0 adhesive force tested within 30 minutes after bonding.

T24 adhesive force tested 24 hours after bonding.

Test method



#### 180 degree peel test



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### Molecule Gradient Double Tac Tape

User is responsible for determining whether the KGK product is fit for a particular purpose and suitable for user's method of application. Please remember that many factors can affect the use and performance of a KGK product in a particular application. The materials to be bonded with the product, the surface preparation of those materials, the product selected for use, the conditions in which the product is used, and the time and environmental conditions in which the product is expected to perform are among the many factors that can affect the use and performance of a KGK product. Given the variety of factors that can affect the use and performance of a KGK product, some of which are uniquely within the user's knowledge and control, It is essential that the user evaluate the KGK product to determine whether it is fit for a particular purpose and suitable for the user's method of application.

KGK make no warranties on above data.

Kyodo giken chemical corporation 940 Minaminagai Tokorozawa-City saitama-Pref 359-0011 Japan Tel : +81 4 2944 5151 Mail : postbox@kgk-tape.co.jp URL : http://www.kgk-tape.co.jp/

